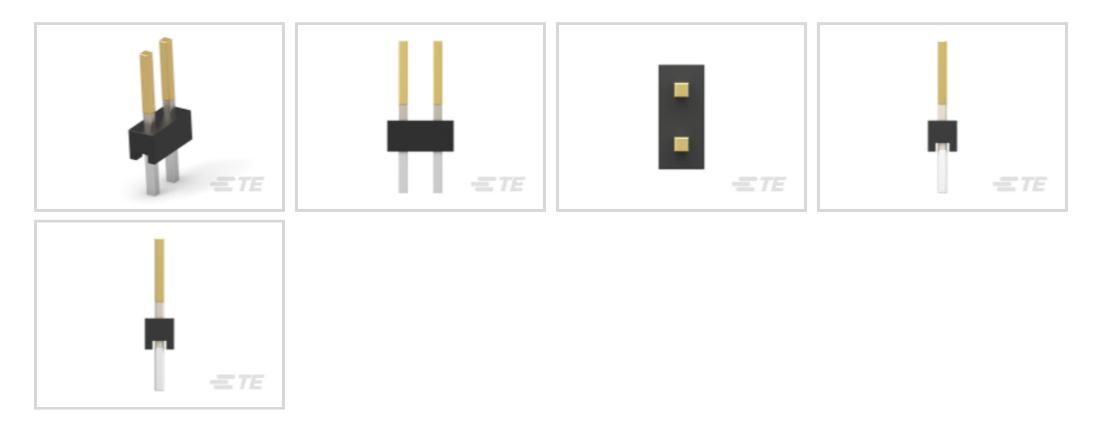


AMPMODU | AMPMODU Headers

TE Internal #: 5-146256-1 PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [. 1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 2

Number of Rows: 2

Features

E

Product Type Features

PCB Connector Assembly Type	PCB Mount Header	
Connector System	Board-to-Board	
Header Type	Breakaway	
Sealable	No	
Connector & Contact Terminates To	Printed Circuit Board	
Configuration Features		
Connector Contact Load Condition	Fully Loaded	
PCB Mount Orientation	Vertical	
Number of Positions	2	
Number of Rows	2	
Board-to-Board Configuration	Parallel	
Electrical Characteristics		
Operating Voltage	30 VAC	
Body Features		

PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers



Connector Profile	Standard
Primary Product Color	Black
Contact Features	
Mating Square Post Dimension	.64 mm[.025 in]
	100 – 200 µin
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Square
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	.381 µm[15 µin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Post & Tail Length	3.05 mm[.12 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	Without
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic
Dimensions	
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]

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PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers



Operation/Application

Solder Process Feature	Board Standoff	
Circuit Application	Signal	
Industry Standards		
Compatible With Approved Standards Products	CSA LR7189, UL E28476	
UL Flammability Rating	UL 94V-0	
Packaging Features		
Packaging Quantity	1040	
Packaging Type	Carton	
Product Compliance For compliance documentation, visit the product page on TE.com>		
EU RoHS Directive 2011/65/EU	Compliant	
EU ELV Directive 2000/53/EC	Compliant	
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold	
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE	

2023 (235) Does not contain REACH SVHC

Low Bromine/Chlorine - Br and Cl < 900 ppm per homogenous material. Also BFR /CFR/PVC Free

Pin-in-Paste capable to 260°C

Halogen Content

Solder Process Capability

Product Compliance Disclaimer

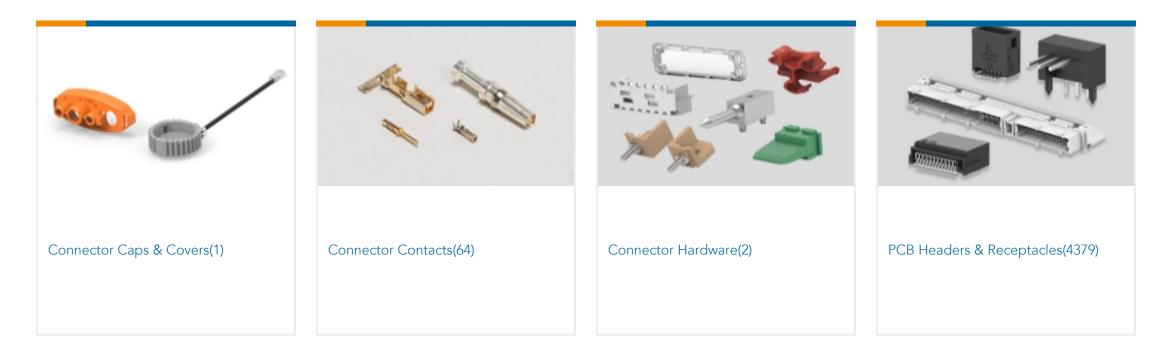
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

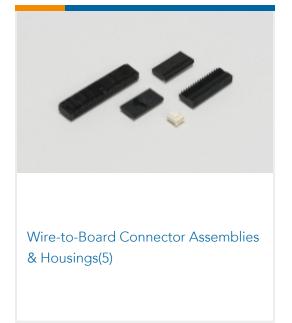
Also in the Series AMPMODU Headers

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Customers Also Bought



TE Part #2-6609104-4 PE0S0DS6B=C1255	TE Part #640452-6 06P MTA100 HDR ASSY SQ STR	TE Part #3-647502-4 04P MTA100 HDR ASSY,SM,SN, LF	TE Part #5745351-4 09 PLUG RA/MS STD
A REAL PROPERTY OF			₹TE
TE Part #2110487-1 QSFP Cage, Solder Leg, No HS Opening	TE Part #6-534206-0 20 MODII VRT DR CE 100/115	TE Part #6-534237-4 16 MODII VRT SR CE 100/115	TE Part #1676285-3 RN 0805 2K21 0.1% 10PPM 5KRL



Documents

PCB Mount Header, Vertical, Board-to-Board, 2 Position, 2.54 mm [.1 in] Centerline, Breakaway, Gold, Through Hole - Solder, Signal, AMPMODU Headers



Product Drawings 02 MODII HDR DRST B/A .100CL LF

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_5-146256-1_E.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_5-146256-1_E.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_5-146256-1_E.3d_stp.zip

English

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Datasheets & Catalog Pages AMPMODU_INTERCONNECTION_SYSTEM_SECTION5

English